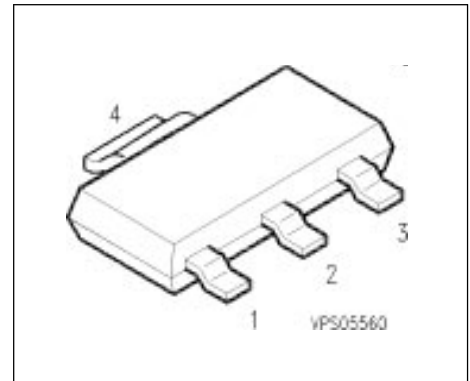


## SIPMOS® Small-Signal Transistor

- P channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = -0.8...-2.0$  V



Pin 1	Pin 2	Pin 3	Pin 4
G	D	S	D

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Marking
BSP 317	-200 V	-0.37 A	6 $\Omega$	SOT-223	
Type	Ordering Code		Tape and Reel Information		
BSP 317	Q67000-S94		E6327		

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	$V_{DS}$	-200	V
Drain-gate voltage $R_{GS} = 20$ k $\Omega$	$V_{DGR}$	-200	
Gate source voltage	$V_{GS}$	$\pm 20$	
Continuous drain current $T_A = 25$ °C	$I_D$	-0.37	A
DC drain current, pulsed $T_A = 25$ °C	$I_{Dpuls}$	-1.48	
Power dissipation $T_A = 25$ °C	$P_{tot}$	1.8	W

## Maximum Ratings

Parameter	Symbol	Values	Unit
Chip or operating temperature	$T_j$	-55 ... + 150	°C
Storage temperature	$T_{stg}$	-55 ... + 150	
Thermal resistance, chip to ambient air	$R_{thJA}$	≤ 70	K/W
Thermal resistance, junction-soldering point <sup>1)</sup>	$R_{thJS}$	≤ 10	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm<sup>2</sup> copper area for drain connection

## Electrical Characteristics, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = -0.25 \text{ mA}, T_j = 25 \text{ }^\circ\text{C}$	$V_{(BR)DSS}$	-200	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = -1 \text{ mA}$	$V_{GS(th)}$	-0.8	-1.1	-2	
Zero gate voltage drain current $V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$	$I_{DSS}$	-	-0.1	-1	μA
$V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125 \text{ }^\circ\text{C}$		-	-10	-100	
$V_{DS} = -130 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$		-	-	-100	nA
Gate-source leakage current $V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	$I_{GSS}$	-	-10	-100	nA
Drain-Source on-state resistance $V_{GS} = -10 \text{ V}, I_D = -0.37 \text{ A}$	$R_{DS(on)}$	-	3.4	6	Ω

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Dynamic Characteristics**

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = -0.37 \text{ A}$	$g_{fs}$	0.25	0.35	-	S
Input capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	-	270	360	pF
Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{oss}$	-	50	75	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	$C_{rss}$	-	15	25	
Turn-on delay time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	8	12	ns
Rise time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_r$	-	30	45	
Turn-off delay time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	80	110	
Fall time $V_{DD} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_f$	-	90	120	

**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

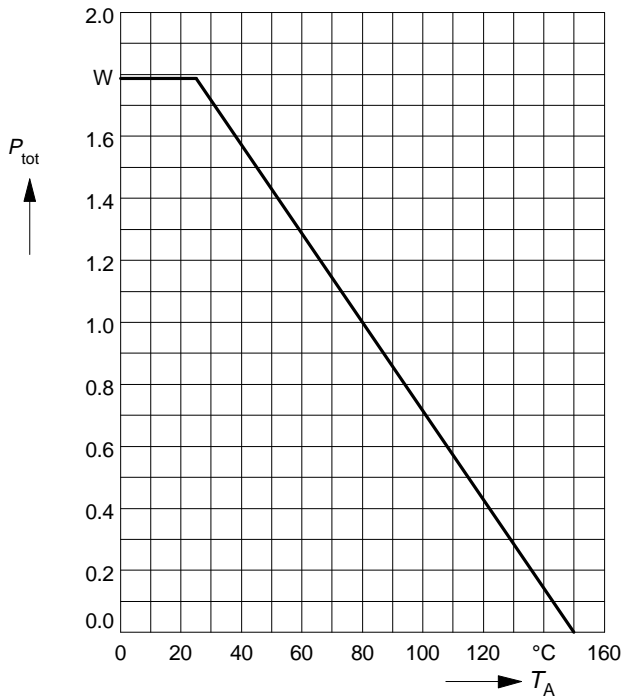
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Reverse Diode**

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	$I_S$	-	-	-0.37	A
Inverse diode direct current, pulsed $T_A = 25^\circ\text{C}$	$I_{SM}$	-	-	-1.48	
Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = -0.74\text{ A}, T_j = 25^\circ\text{C}$	$V_{SD}$	-	-0.95	-1.1	V

### Power dissipation

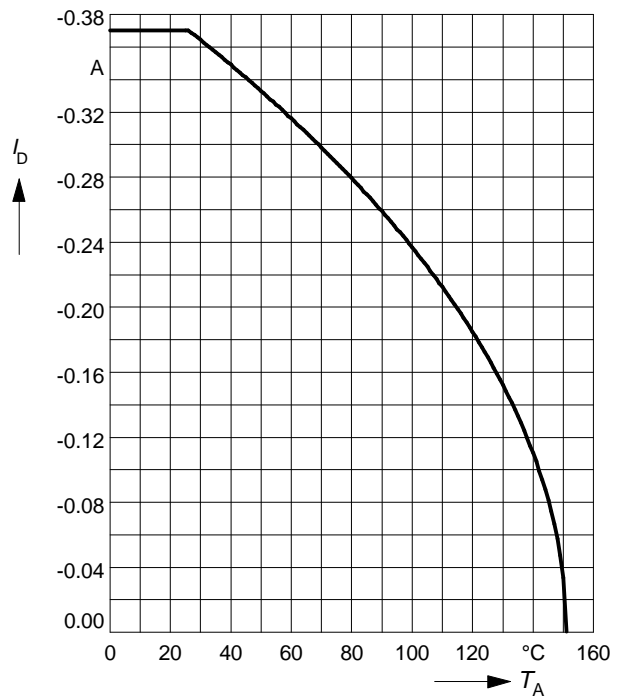
$$P_{\text{tot}} = f(T_A)$$



### Drain current

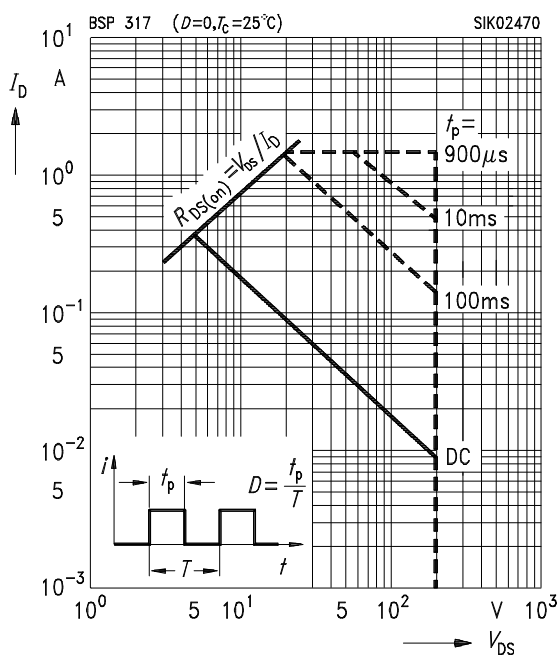
$$I_D = f(T_A)$$

parameter:  $V_{GS} \geq -10 \text{ V}$



### Safe operating area $I_D = f(V_{DS})$

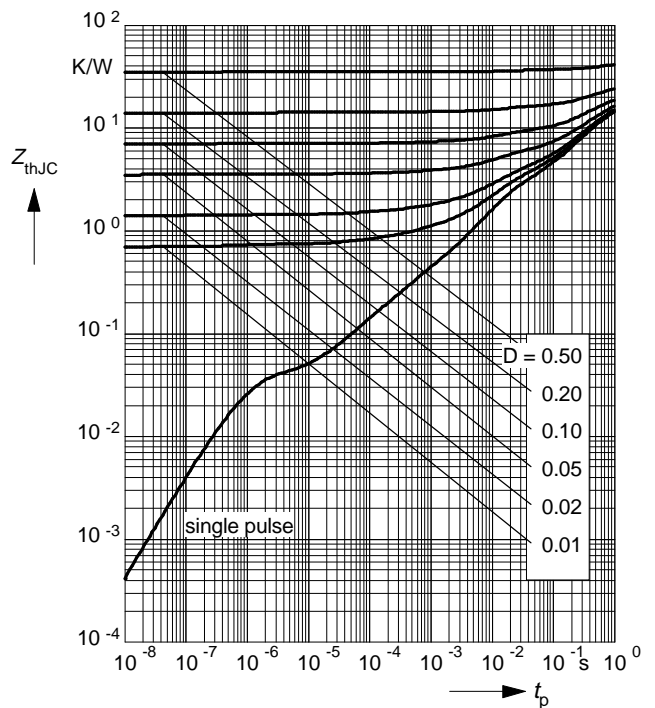
parameter:  $D = 0, T_C = 25^\circ\text{C}$



### Transient thermal impedance

$$Z_{\text{thJA}} = f(t_p)$$

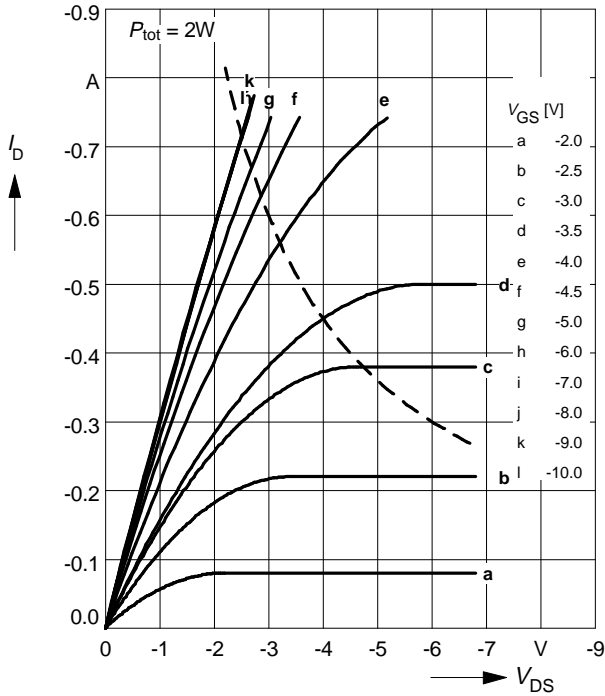
parameter:  $D = t_p / T$



### Typ. output characteristics

$$I_D = f(V_{DS})$$

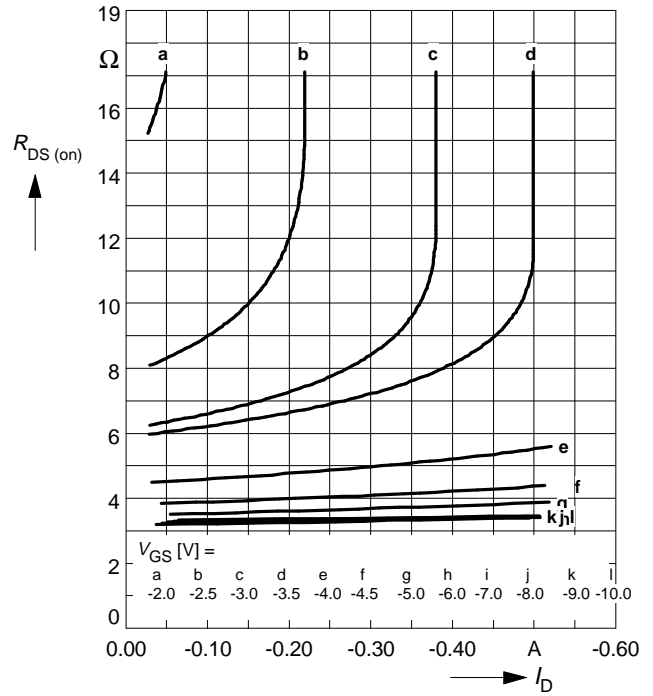
parameter:  $t_p = 80 \mu s$



### Typ. drain-source on-resistance

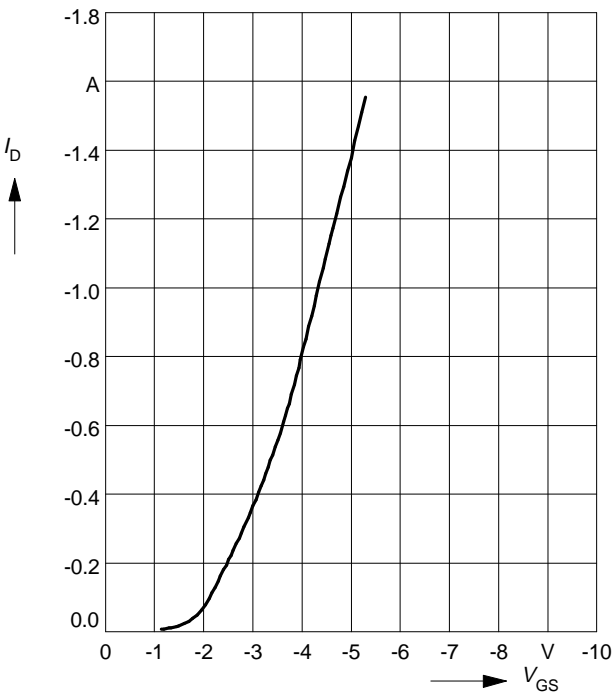
$$R_{DS(on)} = f(I_D)$$

parameter:  $t_p = 80 \mu s, T_j = 25^\circ C$



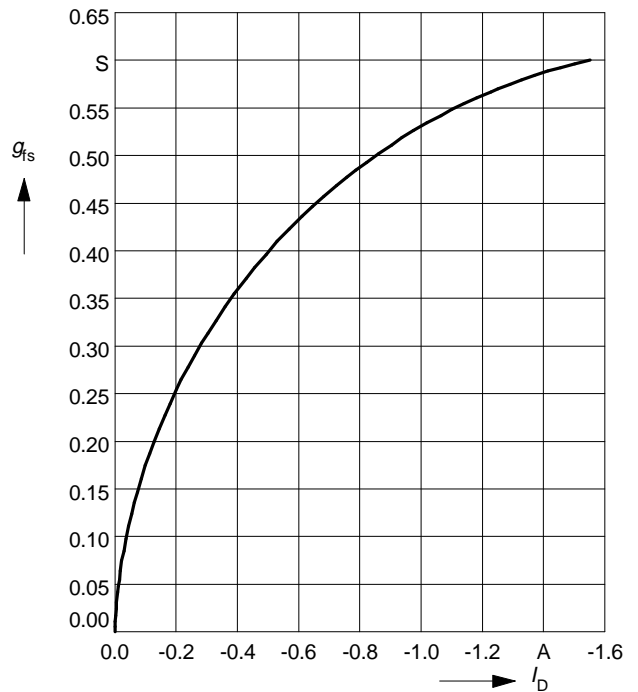
### Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$



### Typ. forward transconductance $g_{fs} = f(I_D)$

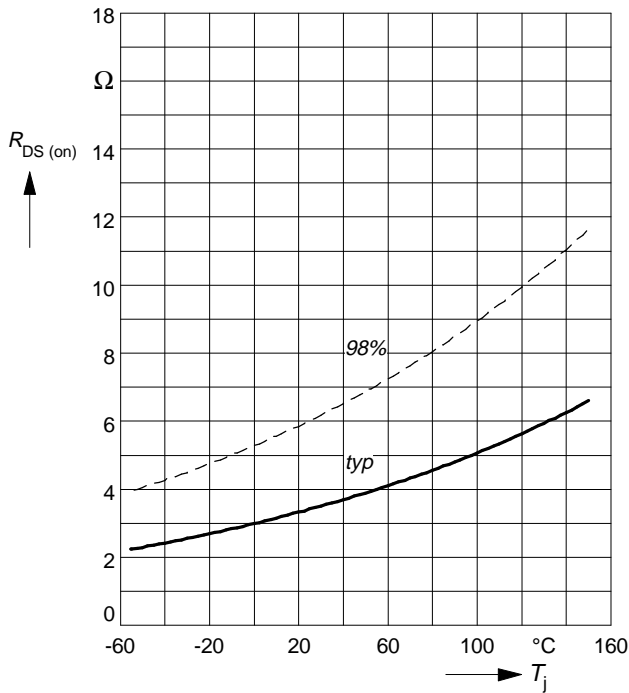
parameter:  $t_p = 80 \mu s$



### Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

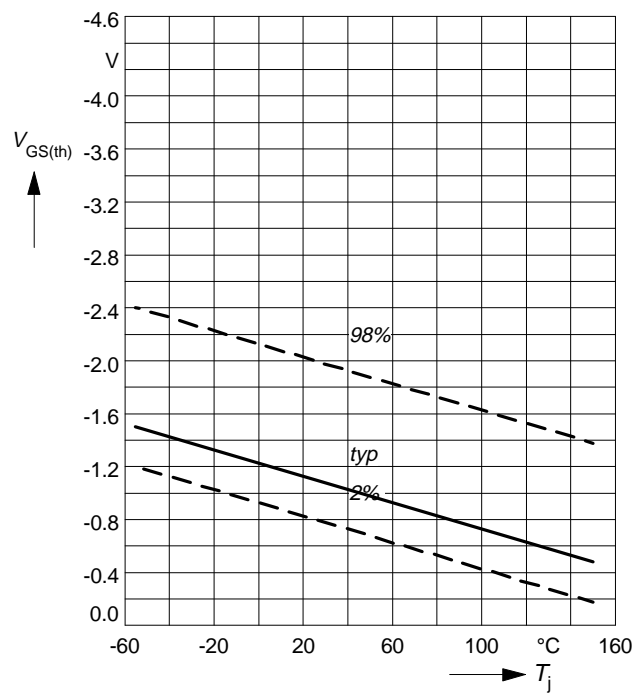
parameter:  $I_D = -0.37$  A,  $V_{GS} = -10$  V



### Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

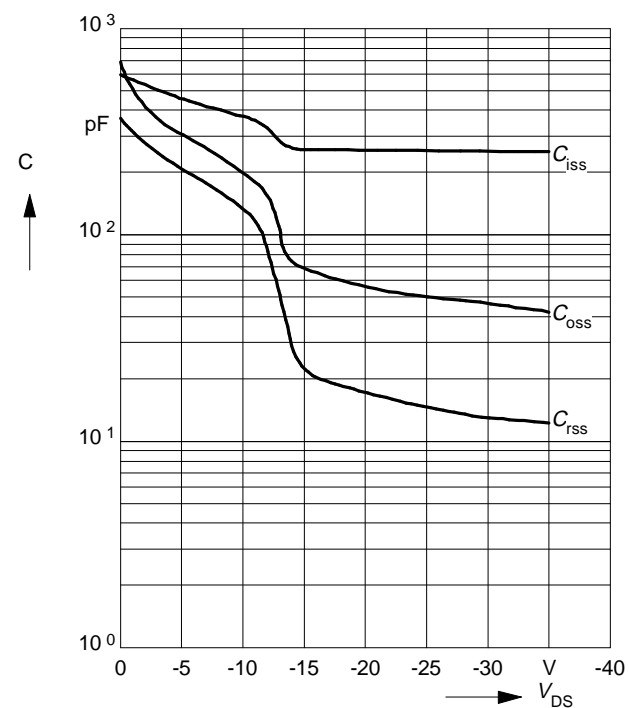
parameter:  $V_{GS} = V_{DS}$ ,  $I_D = -1$  mA



### Typ. capacitances

$$C = f(V_{DS})$$

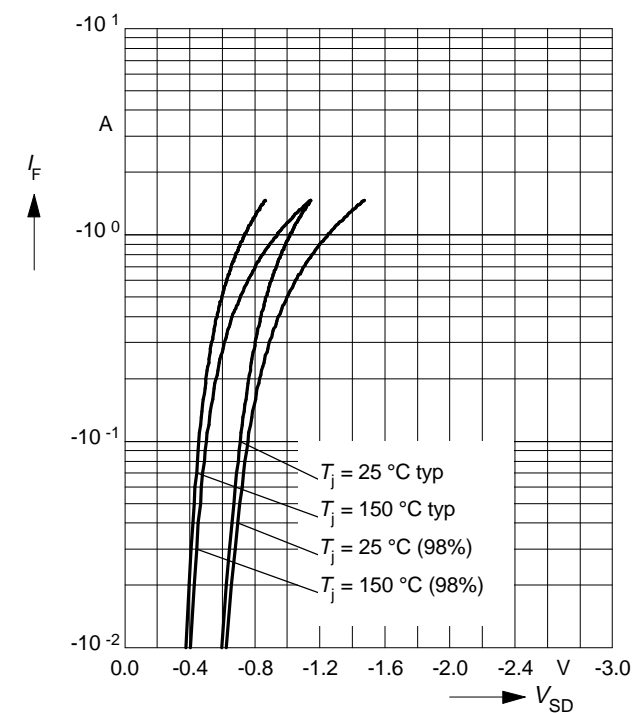
parameter:  $V_{GS}=0$  V,  $f = 1$  MHz



### Forward characteristics of reverse diode

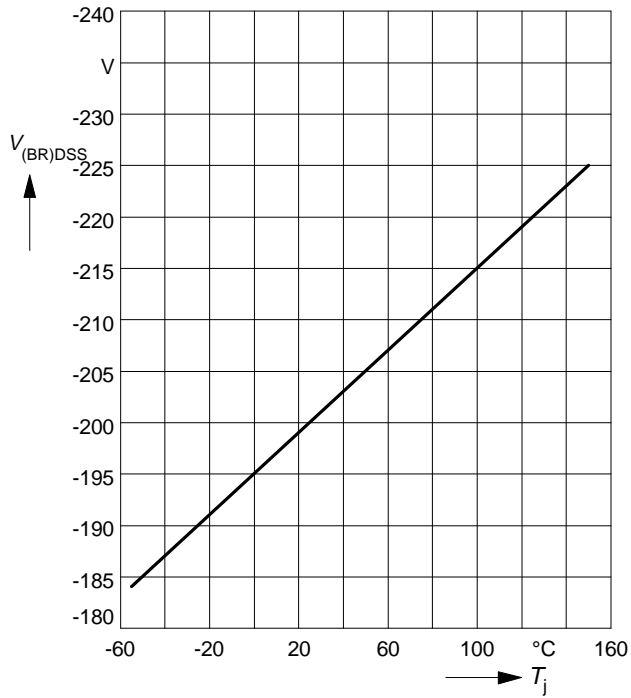
$$I_F = f(V_{SD})$$

parameter:  $T_j, t_p = 80$  μs



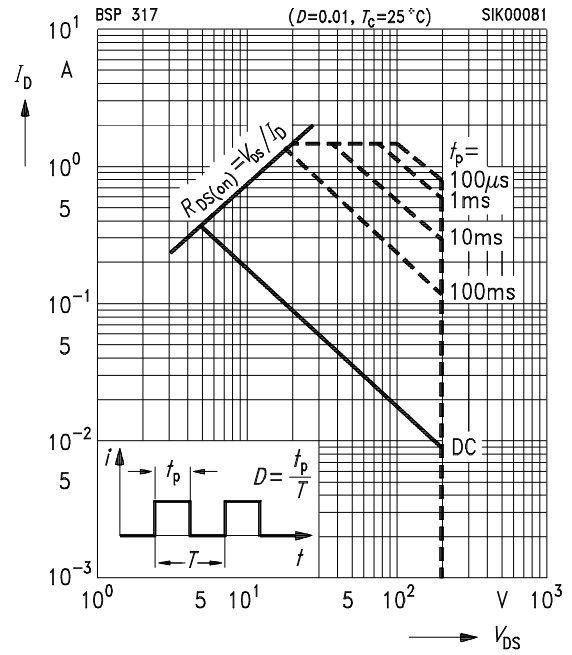
### Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



### Safe operating area $I_D = f(V_{DS})$

parameter :  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$

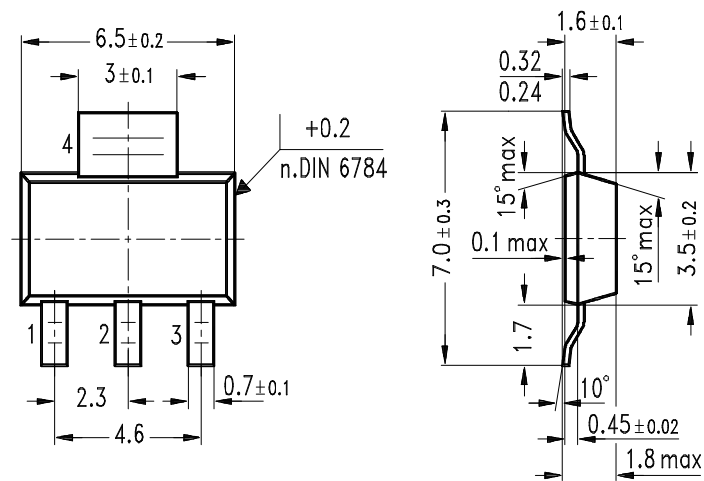




## Package outlines

SOT-223

Dimensions in mm



GPS05560